


## APPLICATION DATA SHEET

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<b>Title of Invention</b>	INTEGRATED CIRCUIT PACKAGE AND PRINTED CIRCUIT BOARD ARRANGEMENT	
Application Type : regular, utility Attorney Docket Number : 71522-0008		
Correspondence address: Customer Number: 20915 		
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as my attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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